



Customer Information Notification

202004014I

Issue Date: 24-Apr-2020
Effective Date: 25-May-2020
Dear *PCN NXP*,

Please find below a Quality Notification that has been distributed by NXP.



Change Category

- | | | | | |
|--|---|--|---|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input checked="" type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other | | | |

i.MXRT1050 / RT1060 / RT106A / RT1064 10x10 196MAPBGA Final Test Site Expansion from NXP-ATTJ to ASECL

Description

NXP Semiconductors is announcing the Final Test site expansion for the I.MXRT1050/RT1060/RT106A/RT1064 10x10 196MAPBGA associated with this notification, from the current NXP ATTJ, Tianjin, China Final Test site to the ASE, Chung-Li, Taiwan Final Test site.

Final Test site expansion was successfully qualified adhering to NXP specifications.

Please see the attached file(s) for additional details.

Reason

Qualification of ASE, Chung-Li, Taiwan is required for manufacturing flexibility and customer supply assurance.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Disposition of Old Products

NXP will reserve the right to ship from any location based on market demand situation.

Additional information

Affected products and sales history information: see attached file

Additional documents: [view online](#)

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Daniel Cheng
Position Product Engineer
e-mail address jian.cheng@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

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NXP Semiconductors
High Tech Campus, 5656 AG Eindhoven, The Netherlands

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